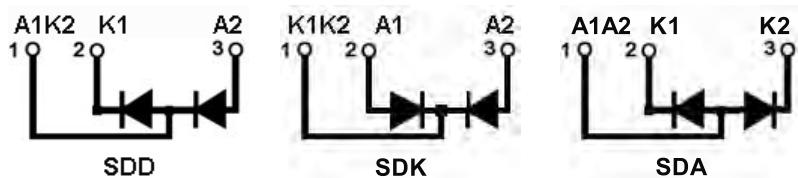


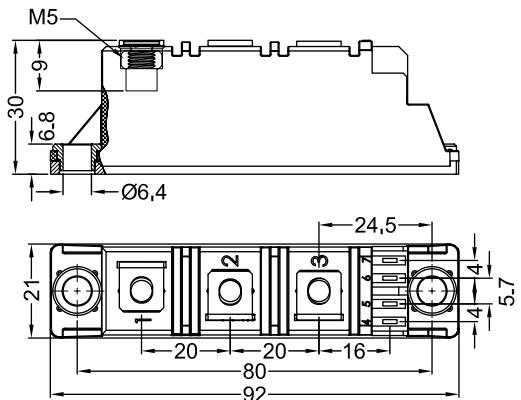
# SDD60NXXB

## Diode-Diode Modules



Type	$V_{RSM}$	$V_{RRM}$
	V	V
<b>SDD60N08B</b>	900	800
<b>SDD60N12B</b>	1300	1200
<b>SDD60N14B</b>	1500	1400
<b>SDD60N16B</b>	1700	1600
<b>SDD60N18B</b>	1900	1800

Holerance: $\pm 0.5\text{mm}$   
Dimensions in mm (1mm=0.0394")



Symbol	Test Conditions	Maximum Ratings	Unit
$I_{FRMS}$	$T_{VJ}=T_{VJM}$	100	
$I_{FAVM}$	$T_c=100^\circ\text{C}$ ; 180° sine	60	A
$I_{FSM}$	$T_{VJ}=45^\circ\text{C}$ $V_R=0$	1150 1300	A
	$T_{VJ}=T_{VJM}$ $V_R=0$	1000 1200	
$\int i^2 dt$	$T_{VJ}=45^\circ\text{C}$ $V_R=0$	6600 7000	$\text{A}^2\text{s}$
	$T_{VJ}=T_{VJM}$ $V_R=0$	5000 5950	
$T_{VJ}$ $T_{VJM}$ $T_{stg}$		-40...+150 150 -40...+125	$^\circ\text{C}$
$V_{ISOL}$	50/60Hz, RMS $I_{ISOL}\leq 1\text{mA}$	3000 3600	V~
$M_d$	Mounting torque (M5) Terminal connection torque (M5)	2.5-4/22-35 2.5-4/22-35	Nm/lb.in.
<b>Weight</b>	Typ.	105	g

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# SDD60NXXB

## Diode-Diode Modules

Symbol	Test Conditions	Characteristic Values	Unit
$I_R$	$T_{VJ}=T_{VJM}$ ; $V_R=V_{RRM}$	10	mA
$V_F$	$I_F=200A$ ; $T_{VJ}=25^\circ C$	1.50	V
$V_{TO}$	For power-loss calculations only	0.8	V
$r_T$	$T_{VJ}=T_{VJM}$	4.3	$m\Omega$
$Q_s$	$T_{VJ}=125^\circ C$ ; $I_F=50A$ ; $-di/dt=0.64A/\mu s$	90	$\mu C$
$I_{RM}$		11	A
$R_{thJC}$	per diode; DC current per module	0.40 0.20	K/W
$R_{thJK}$	per diode; DC current per module	0.60 0.30	K/W
$ds$	Creepage distance on surface	12.7	mm
$da$	Strike distance through air	9.6	mm
$a$	Maximum allowable acceleration	50	$m/s^2$

### FEATURES

- \* International standard package
- \* Copper base plate
- \* Glass passivated chips
- \* Isolation voltage 3600 V~
- \* UL file NO.310749
- \* RoHs compliant

### APPLICATIONS

- \* Supplies for DC power equipment
- \* DC supply for PWM inverter
- \* Field supply for DC motors
- \* Battery DC power supplies

### ADVANTAGES

- \* Space and weight savings
- \* Simple mounting
- \* Improved temperature and power cycling
- \* Reduced protection circuits

# SDD60NXXB

## Diode-Diode Modules

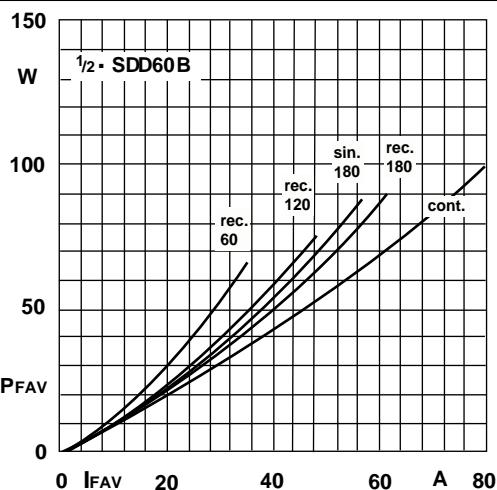


Fig.11L Power dissipation per diode vs. forward current

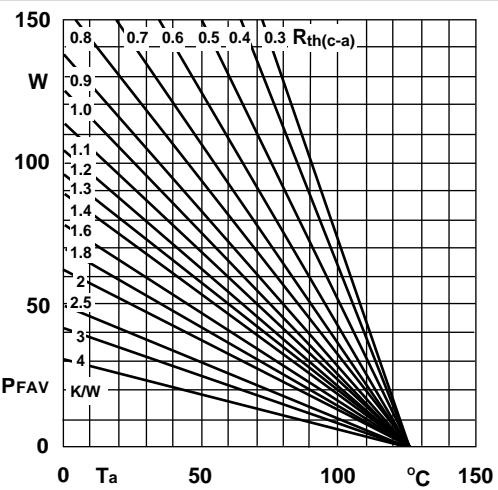


Fig.11R Power dissipation per diode vs. ambient temperature

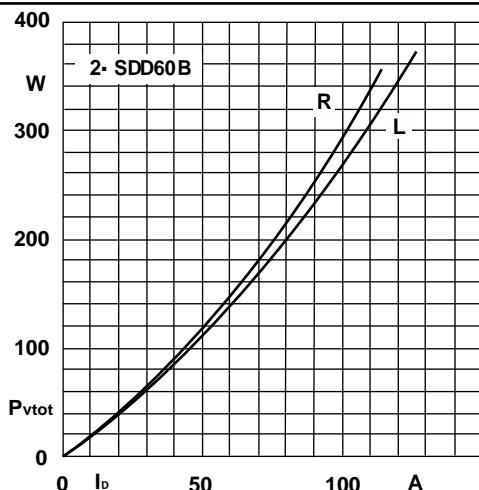


Fig.12L Power dissipation of two modules vs. direct current

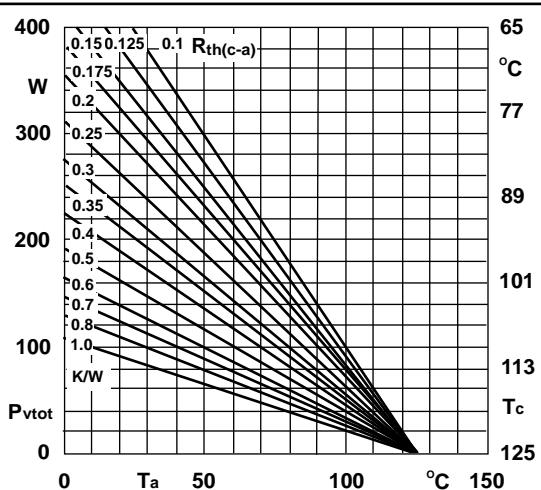


Fig.12R Power dissipation of two modules vs. case temperature

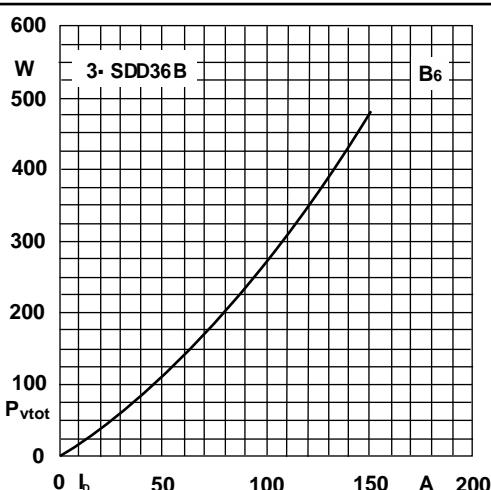


Fig.13L Power dissipation of three modules vs. direct current

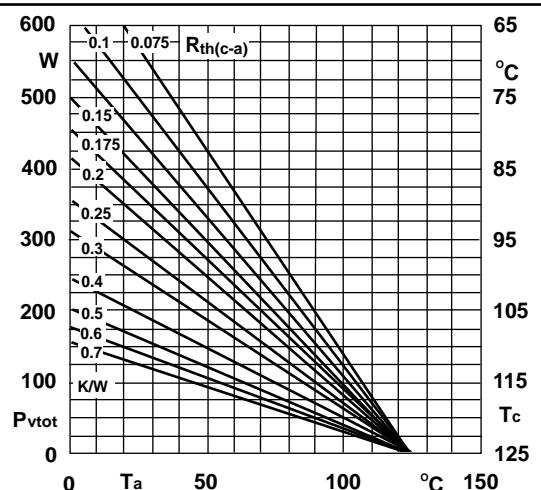


Fig.13R Power dissipation of three modules vs. case temperature

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# SDD60NXXB

## Diode-Diode Modules

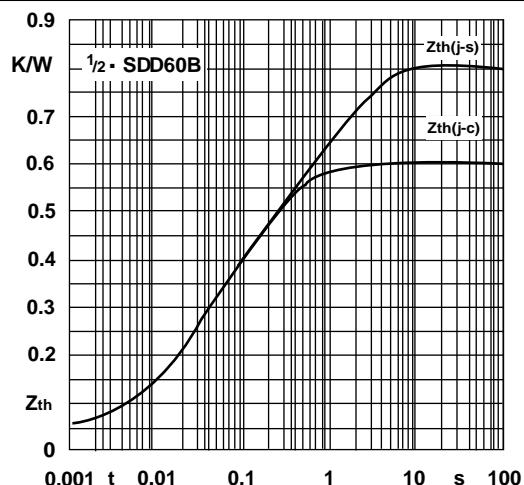


Fig.14 Transient thermal impedance vs. time

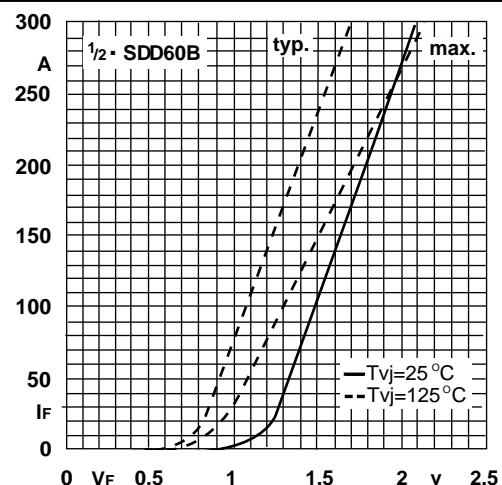


Fig.15 Forward characteristics

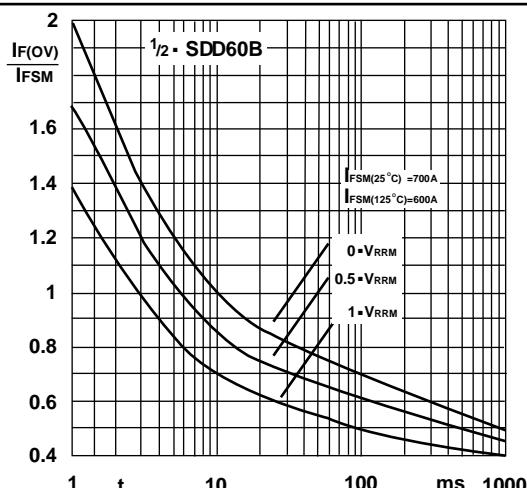


Fig.16 Surge overload current vs. time

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